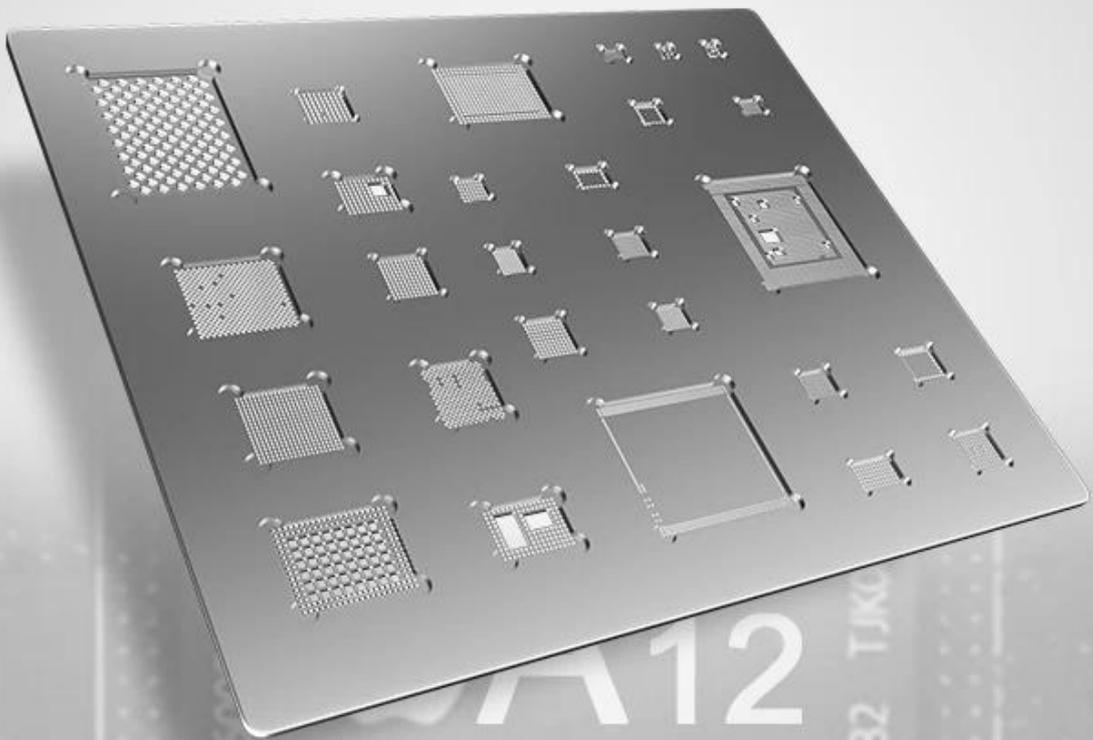


00 00

0 000 Iphone XS / XS MAX / XR 0000 BGA 00 00 0000 000000. 00 00, 00 00, 00 00, 00 00, 0000 00 00, 0 00 00, 00 00, 00 00 0000.

3D GROOVE — REBALLING STENCIL —



SEMI-ETCHING PROCESS



COOLING HOLE DESIGN

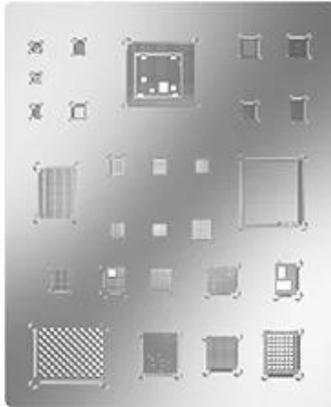


PRECISE ALIGNMENT



SQUARE HOLE

Product Usage



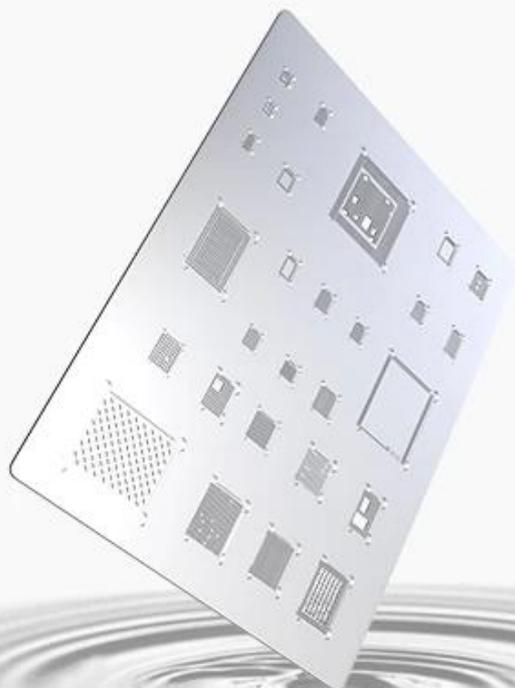
MODEL	A12
WEIGHT	18.6g
MATERIAL	imported steel
SIZE	68.9 X 84.9mm
MATCHING MACHINE TYPE	iPhone XS/XS Max/XR

▼ CHARACTERISTICS

This product is used for BGA tinning repair of the iPhone XS/XS Max/XR series. Imported steel, anti-rolling anti-deformation, automatic alignment, accurate hole position, non-stick tin, good toughness, good off-grid.

IMPORTED STEEL

HIGH TOUGHNESS



Easily mounted on the steel mesh to make the chip fit more closely with the mesh
Therefore, the chip after tinning is "more precise"

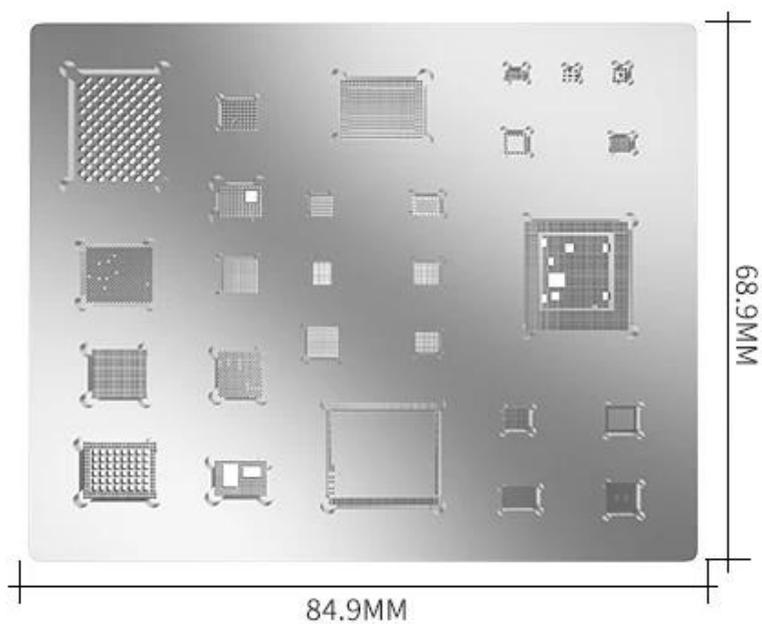
A 3D rendering of an Apple A11Z chip mounted on a steel mesh board. The chip is black with the Apple logo and "A11Z" printed on it. The mesh board is silver and has a grid pattern. The chip is shown in a perspective view, highlighting its fit on the mesh.

A11Z



Imported steel
Hard and wear resistant
Accurate to the hole

PRODUCT SIZE



Thin to 0.33mm

Precise die-casting **form heating**



